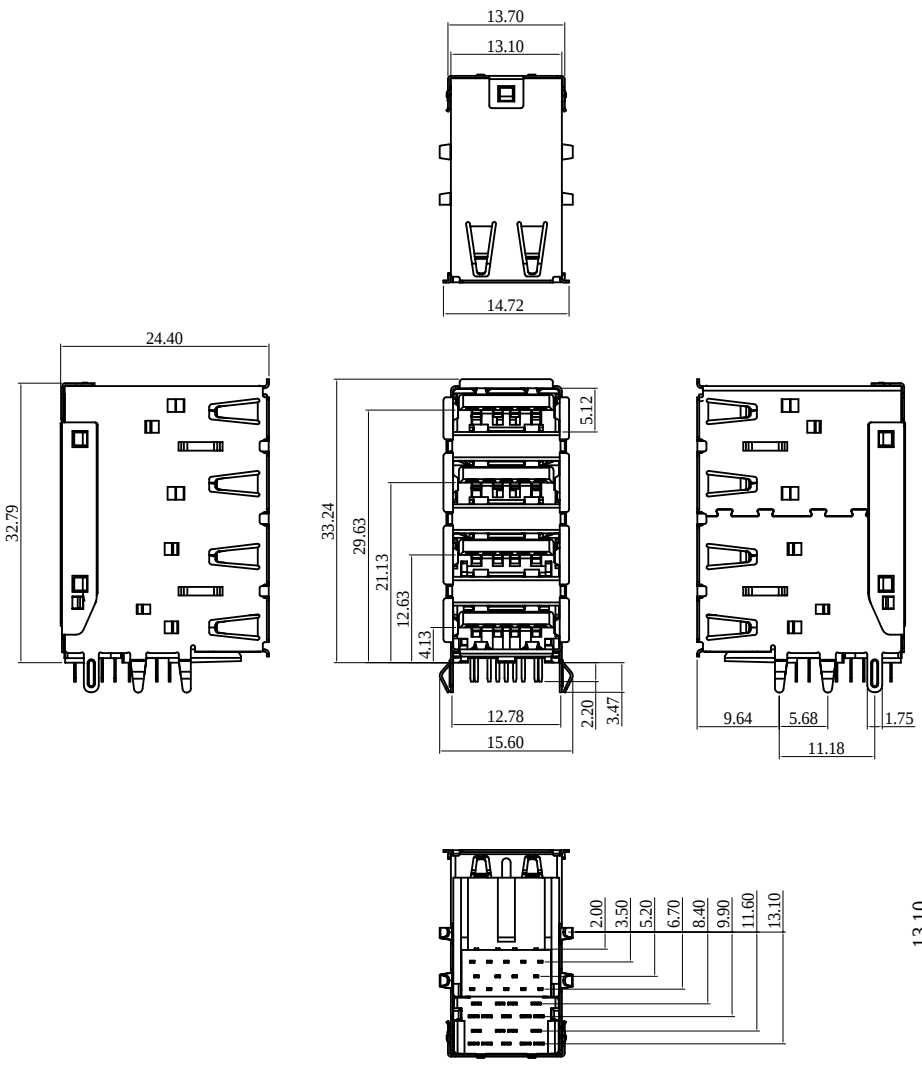
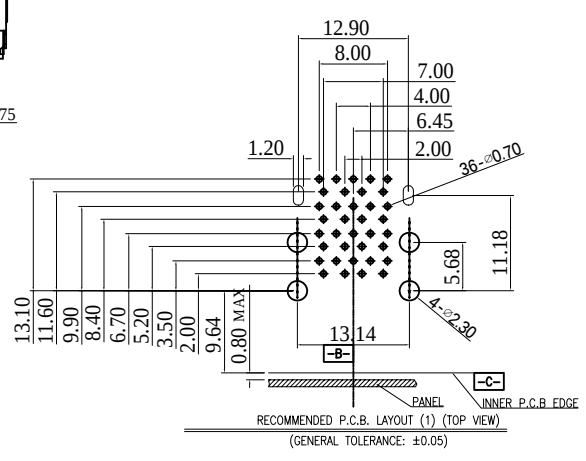


- NOTES:
- MATERIAL:
HOUSING: PA66 WITH 30% GF, UL 94V-0, COLOR: BLUE.
USB 2.0 CONTACTS: COPPER ALLOY.
USB 3.0 CONTACTS: COPPER ALLOY.
SHELL: SUS430.
BLACK SHELL: SUS 304.
MIDDLE BULLET: SK7
 - FINISH:
CONTACTS: GOLD FLASH PLATED ON CONTACT AREA, 2.54um[100u"]MIN. MATTE-TIN PLATED ON SOLDER TAIL, 1.27um[50u"]MIN. NICKEL UNDERPLATED OVER ALL.
SHELL: 1.524um[60u"]MIN. MATTE-TIN PLATED ON SOLDER TAIL, 0.762um[30u"]MIN. NICKEL UNDERPLATED OVER ALL.
MIDDLE BULLET: 2.03um[80u"] NI PLATED.
1.27um[50u"]MIN. CU UNDERPLATED OVER ALL.
 - RECOMMENDED PCB THICKNESS: 1.6mm.
 - WAVE SOLDER CAPABLE TO 245°C

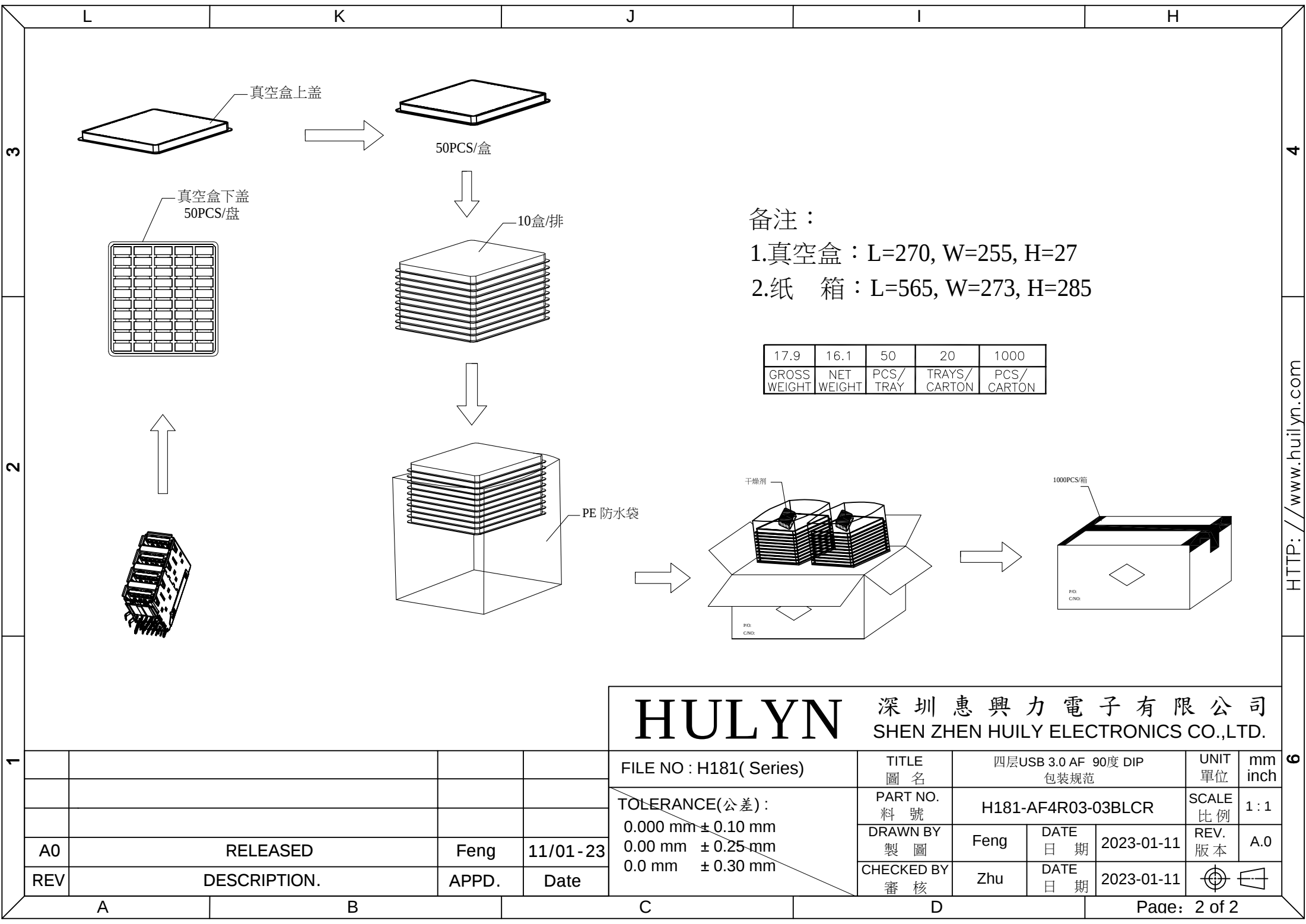
H181-AF4R03-X X X L CR

- Electroplating
0=G/F
2=3u"
3=5u"
4=10u"
5=15u"
6=30u"
- Metal Shell
3=SUS304
- Plastic material
A=PBT
B=PA66
C=PA9T
- Colour
L=BLUE
B=BLACK



A0	RELEASED	Feng	11/01 -23
REV	DESCRIPTION.	APPD.	Date

HULYN		深圳惠興力電子有限公司			
		SHEN ZHEN HUILY ELECTRONICS CO.,LTD.			
FILE NO : H181(Series)		TITLE 圖 名		四層USB 3.0 AF 90度 DIP	
TOLERANCE(公差) :		PART NO. 料 號		H181-AF4R03-03BLCR	
0.000 mm ± 0.10 mm		DRAWN BY 製 圖		DATE 日 期	2023-01-11
0.00 mm ± 0.25 mm		CHECKED BY 審 核		DATE 日 期	2023-01-11
0.0 mm ± 0.30 mm				REV. 版本	
				A.0	



备注：
1.真空盒：L=270, W=255, H=27
2.纸 箱：L=565, W=273, H=285

17.9	16.1	50	20	1000
GROSS WEIGHT	NET WEIGHT	PCS/ TRAY	TRAYS/ CARTON	PCS/ CARTON

HULYN

深圳惠興力電子有限公司
SHEN ZHEN HUILY ELECTRONICS CO.,LTD.

FILE NO : H181(Series)	TITLE 圖 名	四层USB 3.0 AF 90度 DIP 包裝规范		UNIT 單位	mm inch	
TOLERANCE(公差): 0.000 mm ± 0.10 mm 0.00 mm ± 0.25 mm 0.0 mm ± 0.30 mm	PART NO. 料 號	H181-AF4R03-03BLCR		SCALE 比例	1 : 1	
	DRAWN BY 製 圖	Feng	DATE 日 期	2023-01-11	REV. 版本	A.0
	CHECKED BY 審 核	Zhu	DATE 日 期	2023-01-11		

A0	RELEASED	Feng	11/01 -23
REV	DESCRIPTION.	APPD.	Date

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